

Technical Information

6107 Silver Conductor

The thick film silver composition 6107 was formulated specifically as termination metallization for chip and network resistors. Its rheology was optimized for printing of very small components. It does not contain cadmium, nickel, or highly toxic organic solvents. Key features include:

- High Conductivity
- Good Line Resolution
- High Speed Printing
- Compatibility with most Resistor Systems.

TYPICAL FIRED FILM CHARACTERISTICS⁽¹⁾

Fired Thickness	8-12 μm
Line Resolution	175/125 μm line/space using 150/150 μm pattern and 325 mesh screen
Resistivity	≤ 2.50 milliohms / sq at 12 μm fired thickness
Solder Acceptance⁽²⁾ 36/62/2 Sn/Pb/Ag, on 96% alumina	Excellent
Solder Leach Resistance⁽³⁾	> 5 Cycles
Adhesion⁽⁴⁾	
Initial	> 22 N
500 Hours @ 150° C	> 18 N

(1) Typical properties are based on testing of several batches under various processing conditions. They are not intended as specification limits.

(2) Excellent refers to nearly 100% coverage of both pads and lines after a 5-second dip in the solder bath at 225 +/-5°C, using Alpha 611 mildly activated flux.

(3) Cycles consist of 10-second dips in a 225 +/-5°C solder bath. Each cycle is preceded by dipping in Alpha 611 flux. Less than 25% erosion of 2mmx2mm pads.

(4) The adhesion test consists of attaching 20 AWG tinned copper wire to 2mm x 2mm pads, by dipping in 225 +/-5°C solder for 5 seconds. The wires are then bent 90 degrees and pulled, while a force gauge records the peel strength.

COMPOSITION PROPERTIES

Viscosity: 135 ± 15 Kcps, when measured with Brookfield HBT, Spindle #14, utility cup, 10 RPM, 25°C.

Solids Content: 73.50 ± 2.00 %

Recommended Thinner: KOARTAN A-1039

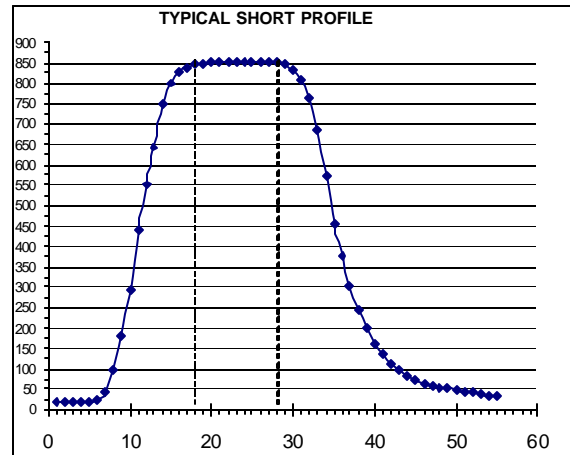
RECOMMENDED PROCESSING PROCEDURE

Printing: Printing with 250 mesh stainless steel screen using 10-15 μm emulsion and 45 degree angle is recommended. Other mesh counts, 200-325, and emulsion thicknesses, 5-25 μm , may be used for special applications. Squeegee speeds of up to 10 inches/sec may be utilized.

Coverage is approximately 80 cm^2 , when utilizing 325 mesh screen and a wet print thickness of about 35 μm .

Drying: Wet prints should be allowed to level for 5-10 minutes prior to drying. Dry for 10-15 minutes in a convection oven or belt dryer at 125°C-150°C.

Firing: Firing in air using a belt furnace and a 36-60 minute profile, with 10 minutes at a peak temperature of 850°C is recommended. Air flow rates must be optimized to ensure that the products of binder burn-off discharge properly and create a fully oxidizing atmosphere in the muffle.



Storage and Shelf Life: Store in tightly capped containers at room temperature. Shelf life is 6 months for unopened jars. Under ordinary conditions of storage and use the product should not require thinning. However, solvent loss during extended printing runs may be replaced by incorporating up to 0.5% of Koartan A-1039 thinner.

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